## Si2393DS

RoHS

COMPLIANT

HALOGEN

FREE

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**Vishay Siliconix** 



#### SOT-23 (TO-236)



#### Marking code: G6

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0227				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.0330				
Q <sub>g</sub> typ. (nC)	8.2				
I <sub>D</sub> (A) <sup>a, e</sup>	-7.5				
Configuration	Single				

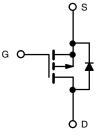
#### **FEATURES**

P-Channel 30 V (D-S) MOSFET

- TrenchFET<sup>®</sup> Gen IV p-channel power MOSFET
- 100 %  $\rm R_g$  and UIS tested
- Material categorization:
- for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Load switch
- Circuit protection
- Motor drive control



P-Channel MOSFET

ORDERING INFORMATION			
Package	SOT-23		
Lead (Pb)-free and halogen-free	Si2393DS-T1-GE3		

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	-30	V
Gate-source voltage		V <sub>GS</sub>	-20 / +16	v
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-7.5 <sup>e</sup>	
	T <sub>C</sub> = 70 °C		-6.9	
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-6.1 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		-4.8 <sup>b, c</sup>	А
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	-50	
	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	-2.1	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C		-1.1 <sup>b, c</sup>	
	T <sub>C</sub> = 25 °C		2.5	
Maximum power dissipation	T <sub>C</sub> = 70 °C		1.6	14/
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.3 <sup>b, c</sup>	W
	T <sub>A</sub> = 70 °C	1	0.8 <sup>b, c</sup>	
Operating junction and storage temperature	e range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient <sup>b</sup>	t ≤ 5 s	R <sub>thJA</sub>	75	100	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJF</sub>	40	50	0/10	

#### Notes

a. Based on  $T_C$  = 25  $^\circ C$ 

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. Maximum under steady state conditions is 166 °C/W

e. Package limited

S19-0382-Rev. A, 29-Apr-2019

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•	•		•	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = -250 μA	-	-24.7	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	5.7	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	-1	-	-2.2	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = -20 V / +16 V$	-	-	100	nA	
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	uA	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS}$ = -30 V, $V_{GS}$ = 0 V, $T_{J}$ = 70 °C	-	-	-15		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge$ -10 V, $V_{GS}$ = -10 V	-10	-	-	Α	
	5	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -5 A	-	0.0189	0.0227		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3 \text{ A}$	-	0.0264	0.0330	- Ω	
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -5 A	-	10	-	S	
Dynamic <sup>b</sup>			•	•		1	
Input capacitance	C <sub>iss</sub>		- 1	980	-		
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	440	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	55	-		
Total gate charge	Qg	$V_{DS}$ = -15 V, $V_{GS}$ = -10 V, $I_{D}$ = -6.1 A	-	16.8	25.2	nC	
			-	8.2	12.3		
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -15 V, $V_{GS}$ = -4.5 V, $I_{D}$ =-6.1 A	-	3.6	-		
Gate-drain charge	Q <sub>qd</sub>		-	2.8	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	3.6	18.3	36.6	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	14	28		
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 2.5 \Omega, \text{ I}_{\text{D}} \cong -4.8 \text{ A},$	-	8	16	1	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = -10 V, $R_g$ = 1 $\Omega$	-	48	96		
Fall time	t <sub>f</sub>		-	32	64		
Turn-on delay time	t <sub>d(on)</sub>		-	30	45	ns	
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{I}} = 2.5 \Omega, \text{ I}_{\text{D}} \cong -4.8 \text{ A},$	-	85	170		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = -4.5 \text{ V}, \text{ R}_{g} = 1 \Omega$	-	34	68		
Fall time	t <sub>f</sub>		-	40	80		
Drain-Source Body Diode Characterist	cs		•	•		1	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-2.1		
Pulse diode forward current	I <sub>SM</sub>		-	-	-50	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -4.8 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>	· • • •	-	21	42	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -4.8 A, di/dt = 100 A/μs,	-	8	16	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_{\rm J} = 25 ^{\circ}{\rm C}$	-	8.5	-		
Reverse recovery rise time	t <sub>b</sub>		-	12.5	-	ns	

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

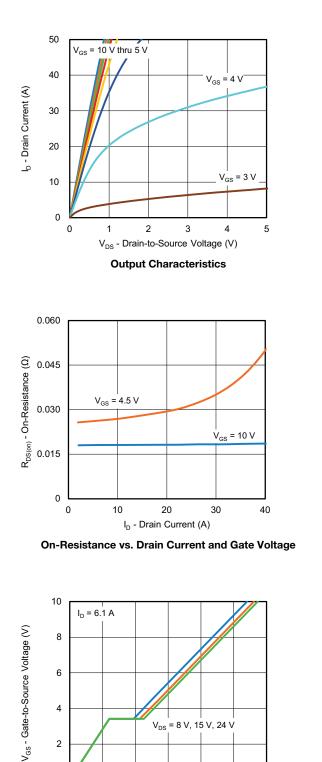
b. Guaranteed by design, not subject to production testing

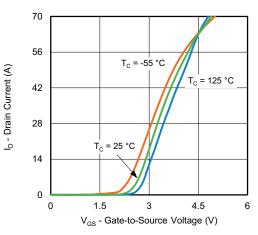
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

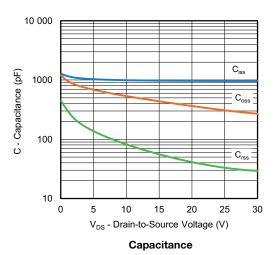


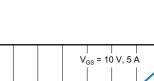
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



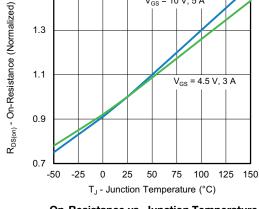


**Transfer Characteristics** 





1.5



**On-Resistance vs. Junction Temperature** 

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2

0

0

3

6

9

Q<sub>q</sub> - Total Gate Charge (nC)

**Gate Charge** 

12

15

18

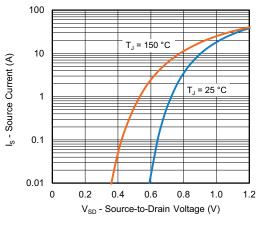
3

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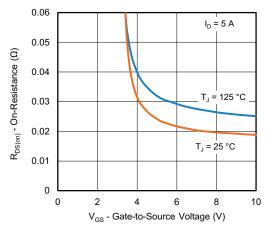
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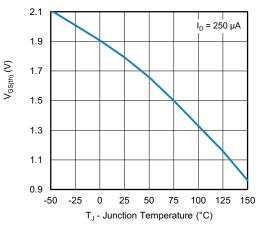
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



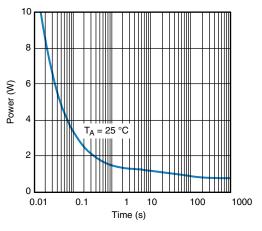
Source-Drain Diode Forward Voltage



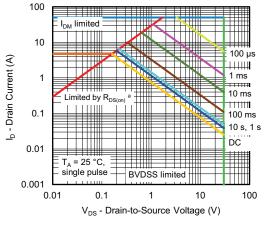
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

#### Note

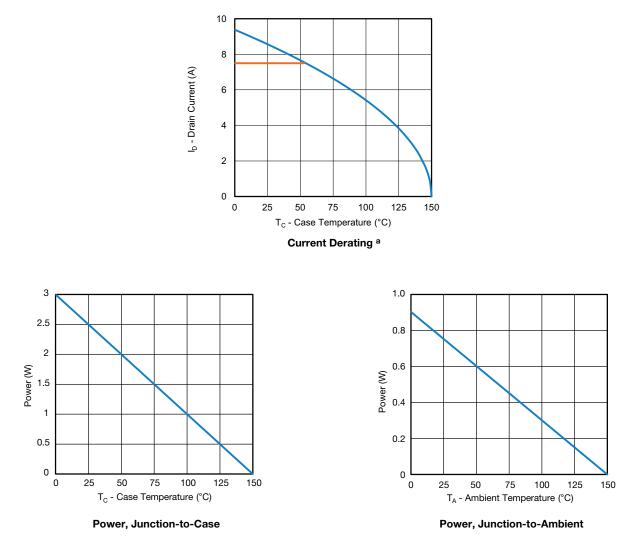
a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### Note

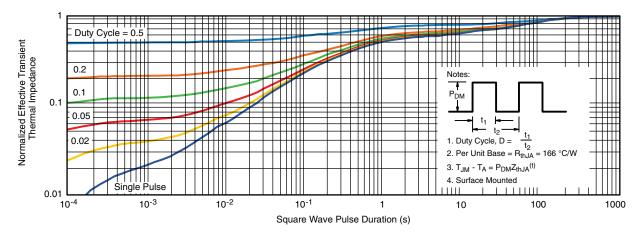
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



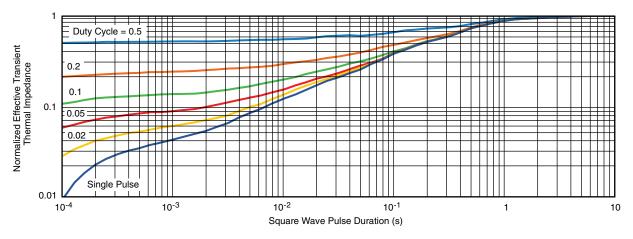
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?70132">www.vishay.com/ppg?70132</a>.



# Package Information

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## SOT-23 (TO-236): 3-LEAD



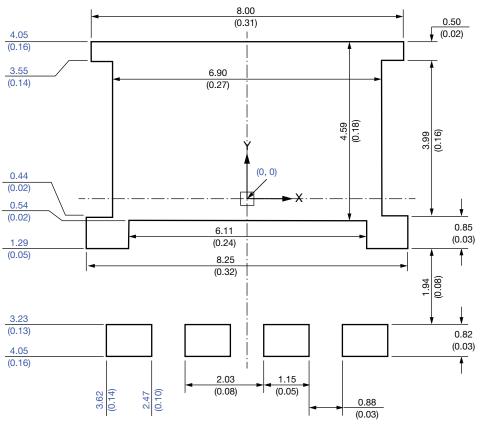




Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95	5 BSC	0.037	4 Ref	
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025	5 Ref	
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



# **Recommended Minimum PADs for PowerPAK® 8 x 8L Single**



Dimensions in millimeters (inches)

#### Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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